

Title (en)
POLYMERIC BEADS AND METHODS OF MAKING POLYMERIC BEADS

Title (de)
POLYMERKÜGELCHEN UND VERFAHREN ZUR HERSTELLUNG VON POLYMERKÜGELCHEN

Title (fr)
BILLES POLYMÈRES ET MÉTHODES DE FABRICATION DE BILLES POLYMÈRES

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Application
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Priority

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- US 94114807 P 20070531

Abstract (en)
[origin: WO2007146722A1] Polymeric beads and methods of making the polymeric beads are described. The polymeric beads are crosslinked hydrogels or dried hydrogels. The polymeric beads are formed from droplets of a precursor composition that are exposed to radiation. The droplets are totally surrounded by a gas phase. The precursor composition contains a polar solvent and a polymerizable material miscible in the polar solvent. The polymerizable material has an average number of ethylenically unsaturated groups per monomer molecule equal to at least 1.2.

IPC 8 full level
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Citation (search report)

- [XA] WO 2006002641 A1 20060112 - VERSAMATRIX AS [DK], et al
- [X] EP 1371668 A1 20031217 - SEKISUI CHEMICAL CO LTD [JP]
- [XA] WO 2005062018 A2 20050707 - VERSAMATRIX AS [DK], et al
- See references of WO 2007146722A1

Designated contracting state (EPC)
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DOCDB simple family (publication)
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